



Tenum™ 640 Thermal Camera Cores

Unrivaled. Uncompromised. A New Frontier in Infrared Technology in a 10-Micron Uncooled Thermal Core.



With unrivaled design and unwavering performance, Tenum™ 640 precisely balances ultra-small pixel structure with ultra-sensitive microbolometer performance at a remarkable cost advantage. The 10-micron pixel pitch Vanadium Oxide (VOx) technology behind Leonardo DRS' Tenum™ 640 is the most advanced uncooled infrared sensor design available to Original Equipment Manufacturers (OEMs) today.

This revolutionary detector design enables greater affordability while delivering an uncompromised thermal imaging performance. The high-resolution 640 x 512 array size offers superior long-wave infrared (LWIR) detection at 60 fps and the incredible sensitivity (less than 50 mK NETD) is ideal for a variety of OEM applications.

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DATA SHEET



Tenum™ 640 OEM Thermal Camera Cores

[Download the data sheet](#)

FEATURES

- 640 x 512 pixel resolution
- Unrivaled. Uncompromised. A New Frontier in Infrared Technology in a 10-Micron Uncooled Thermal Core.
- High sensitivity LWIR imaging and unparalleled SWaP benefits
- Lensless configuration 31.3 x 28.8 x 27.2 mm



TENUM™₆₄₀
UNCOOLED THERMAL
CORES



10-MICRON PIXEL PITCH. UNRIVALED. UNCOMPROMISED. A NEW FRONTIER IN INFRARED TECHNOLOGY.

TENUM™₆₄₀ OEM THERMAL CAMERA CORES

With **unrivaled design** and **unwavering performance**, Tenum™₆₄₀ precisely balances **ultra-small pixel** structure with **ultra-sensitive microbolometer performance** at a remarkable cost advantage. The **10-micron pixel pitch** Vanadium Oxide (VOx) technology behind Leonardo DRS' Tenum™₆₄₀ is the **most advanced uncooled infrared sensor design available** to Original Equipment Manufacturers (OEMs) today.

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TENμm™₆₄₀

TEN μ m™ 640

FOCAL PLANE ARRAY

| COMPONENT | DESCRIPTION |
|--|-----------------------------|
| Detector Type | Uncooled VOx Microbolometer |
| Array Size | 640 x 512 (ICE™, 14-bit) |
| Pixel Pitch | 10 μ m |
| Spectral Band | 8-14 μ m |
| Sensitivity (NE Δ T) @ f/1.0 @ Room Temperature | <50 mK |

VIDEO FORMAT

| | |
|---------------------------|--|
| Frame Rates | 60 fps / 9 fps |
| Analog Video | NTSC (480i); NTSC PAL, Black and White or Color |
| Digital Video | 14-bit/8-bit LVCMOS or Camera Link® |
| Automatic Gain and Level | User defined and persistent through power cycles |
| Digital Zoom and Pan | Region of Interest, E-zoom from 1X - 4X |
| Non-Uniformity Correction | 1-point with shutter or through lens |
| Time to First Image | < 3.0 seconds |

POWER

| | |
|-----------------------------|---|
| Input Voltage | 3 - 5.5 V Base Configuration (BC) 4.5 - 18 V BC with Feature Board |
| Power Dissipation (nominal) | < 1.2 W Base Configuration < 1.4 W BC with Feature Board |
| PoUSB (Power over USB) | Requires Feature Board |

LENS CONFIGURATIONS

| EFFECTIVE FOCAL LENGTH (EFL) | FIELD OF VIEW (FOV) (H° X V°) | F/# | WEIGHT (IN GRAMS) | DIMENSIONS ** (H X W X D) (\pm 0.5) IN MM |
|------------------------------|-------------------------------|-----|-------------------|--|
| No Lens | No Lens | N/A | 29 | 31.3 x 28.8 x 27.2 |
| 7.7 mm | 49° x 40° | 1.3 | 39 | 31.3 x 28.8 x 34.2 |
| 15 mm | 25° x 20° | 1.2 | 45 | 31.3 x 28.8 x 41.0 |
| 20mm | 18° x 15° | 1.2 | 48 | 31.3 x 28.8 x 43.2 |

** Without Feature Board.

ENVIRONMENTAL

| COMPONENT | DESCRIPTION |
|--------------------------|--|
| Operating Temp Range | -40°C to +80°C (-40°F to +176°F) |
| Shock / Vibration | 75 G (all axis) / 4.43 g _{rms} (three axis) |
| EMC Radiation | FCC Class A digital device |
| Humidity | 5 to 95%, non-condensing |
| Standards Compliance | ROHS and WEEE Compliant |
| Sealed lens / lens mount | IP 67 |

CONFIGURATIONS

| | |
|-------------------------|---------------------------------------|
| Base Configuration (BC) | Detector, Bias Board, Processor Board |
| With Feature Board (FB) | Base configuration with Feature Board |

STANDARD FEATURES

| | |
|-----------------------------|---|
| Available Command Protocols | LVCMOS UART; RS-232; USB 2.0 |
| Image Enhancement | Image Contrast Enhancement (ICE™) |
| External Sync | Yes |
| Color | 24-bit RGB and YUV (4,2,2) |
| Tenum™ Toolbox | Design environment for custom symbology and interface development |
| 3-D Noise Filter | User option to enable < 30 mK NETD |

Specifications subject to change without notice.
The products described herein are subject to US Government Export Controls.
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